



LIQUID COOLING AT NASA AMES

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- Building N258, a traditional legacy data center, built in 1986. Home to Pleiades & Cabeus Computers, PUE: 1.36.
 - 4MW IT equipment, approximately 300 racks.
 - 1MW Cooling System (3+1 Chillers & Cooling Tower). Raised floor cooling with rear-door heat exchangers on compute racks.
- R&D088, Prototype Modular Data Center Facility, built in 2016 & 2017. Home to Electra Computer. PUE: 1.04.
 - 1.4 MW - 18 air cooled racks & 16 HPE Apollo 8600 (HPE E-Cells).
 - MDC1 uses filtered outside air & evaporative cooling over 81° F.
 - MDC2 uses water cooled heatsinks on processors – process water cooled by dry air and evaporative cooler to 80° F.
- R&D099, Modular Supercomputing Facility, built in 2019. Home to Aitken Computer. PUE: 1.044.
 - 2.1 MW - 8 Apollo 8600 & 16 HPE Apollo 9000
 - Water cooled heatsinks on processors plus Apollo 9000 has water cooled circuit boards, eliminating fans – process water cooled by dry and evaporative cooler to 90° F.

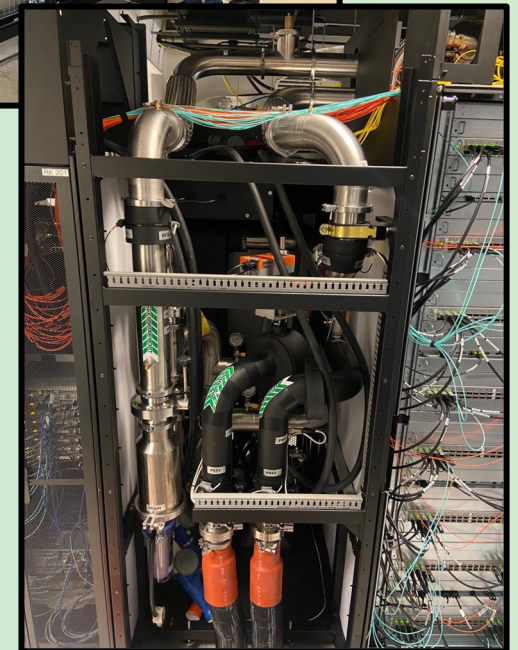


NASA Ames Liquid Cooling Technology Changes with Compute Technology

- Our Implementation of Liquid Cooling is driven by the compute and vendor's technology. While air cooling is the easiest to implement, it's not always the best.
- The N258 Main Data Center has implemented Liquid Cooling since the late 1980's with the installation of the Fluorinert cooled Cray 2 computer.
- As Cluster Computing took over in the mid-2000's, we transitioned to Rear-Door Heat Exchangers (Cooling Doors).
 - As rack power started to increase above 15kW, our hot air containment was inadequate to maintain the proper rack inlet temperature.
 - Cooling doors closely coupled the cooling water/coils to the heat source and eliminated hot air spill over.
 - Our hot aisle went from 4 feet to 4 inches.
- In 2017, we installed our first Direct-to-Chip Liquid Cooling system in a Modular Data Center.
 - In addition, the system is Warm Water Cooled.
 - The Primary Water loop is cooled by an Adiabatic Cooler to 80F.
 - The Secondary Water Loop that flows through the Cold Plate mounted on top of the Processor has a 85F supply temperature.
 - Other electrical components (memory, power supplies, etc.) are closed-loop, force-air cooled with the circulating air cooled at an air-to-liquid heat exchanger cooled by the primary loop (80F supply).
- In 2020, we installed a Liquid-Only Cooled System; NO Fans!
 - The Primary Water loop supply temperature is 90F and the Secondary Water Loop supply temperature is 95F.
 - All electrical components are cooled by the cold plate (95F supply)

Our Most Recent Liquid Cooling Installation

- Installed on October 31, 2023, a 4 rack Liquid-Cooled Compute System in a room previously used for air-cooled systems.
 - Rack power is 108kW per rack.
- While the room once was all raised floor, half the floor was removed 10 years ago to site a Quantum Computer. With the Quantum Computer decommissioned two years ago, the new system was sited on the concrete subfloor.
 - Liquid-cooled systems are heavy and our data center's raised floor was not rated for the weight of the new system.
- Chilled water from existing 3-inch piping previously used by long-removed Computer Room Air Handlers was plumbed from under the leftover raised floor into the compute system's Cooling Distribution Unit.
 - The chilled water supply temperature is 50F at 150 GPM.
- Chilled Water Piping runs on the floor while Power and Network are distributed from above.
- Two 4-Ton mini split air conditioners cool the air-cooled I/O rack.
- This is a temporary install as the compute system will be moved in about 6 months to our coming new Modular Data Center, where it will have a 90F supply temperature.



Benefits & Challenges to Liquid Cooling

Benefits

- Allows for compute density, shorter interconnects, faster speeds.
- Higher Density allows for less floor space: our 4-rack Liquid Cooled system has 65,000 cores, the equivalent of 32 racks with cooling doors on our main computer floor.
- Liquid Cooling is more energy efficient than air cooling. Our Warm-water, Liquid Cooled systems have a PUE of 1.04, while our chilled water systems are at 1.36.
- Liquid cooling allows high power racks to coexist with low power racks in data centers with less than perfect containment.

Challenges

- Adding new piping to the subfloor requires available subfloor room. The photo to the right is the piping manifold and valves filling our entire 24-inch subfloor.
- As rack power increases, flow rates and piping sizes increase too. Large, water filled pipes are heavy, requiring significant support.
- The subfloor needs to be rated for the addition loading of liquid cooling equipment. The cooling door shown weighs 400 lbs.
- Liquid-cooled doors take up aisle space. Our typical 4 foot hot aisle shrank to 18 inches when the doors were installed. Racks need to be spread apart to account for door thickness.
- Water leaks typically occur in the underfloor brass shutoff valve bodies, but the occurrence is infrequent.

